## **AMENDMENTS TO THE CLAIMS**

1. (Currently Amended) A method of manufacturing a circuit forming board, comprising: transferring a first sheet, which extends in a first direction, in a second direction such that the first direction of the first sheet is parallel to the second direction; and

sticking films onto both surfaces of the first sheet while transferring the first sheet in a third direction orthogonal to the first direction of the first sheet, the films being arranged to be peeled off from the first sheet.

- 2. (Previously Presented) The method as defined in claim 1, wherein said sticking of the films further comprises pressing the films on the first sheet with a heated roller while transferring the first sheet in the third direction.
- 3. (Previously Presented) The method as defined in claim 1, wherein said transferring of the first sheet in the second direction further comprises impregnating a reinforcing member with impregnation material while transferring the reinforcing member in the second direction so as to provide the first sheet, the reinforcing member extending in a direction corresponding to the first direction of the first sheet, the direction of the reinforcing member being parallel to the second direction.
- 4. (Original) The method as defined in claim 3, wherein the reinforcing member comprises woven fabric.
- 6. (Original) The method as defined in claim 1, further comprising: forming a via-hole in the first sheet having the films stacked thereon; filling the via-hole with conductive paste; peeling off the films from the first sheet; and heating and pressing metallic foils onto both surfaces of the first sheet after said peeling off the films.

6. (Original) The method as defined in claim 1, wherein the first sheet has a rectangular shape having a long-side direction and a short-side direction, and the long-side direction is orthogonal to the first direction of the first sheet.

## 7-9. (Cancelled)

- 10. (Previously Presented) The method as defined in claim 1, wherein the first sheet has a side which extends in the first direction.
- 11. (Previously Presented) The method as defined in claim 1, wherein said transferring of the first sheet comprises transferring a plurality of separate first sheets, each of which extends in the first direction, and wherein said sticking of the films comprises sticking films onto both surfaces of each of the separate first sheets while transferring each of the separate first sheets in the third direction.
- 12. (Previously Presented) The method as defined in claim 11, wherein the sticking of the films comprises sticking continuous films onto both surfaces of each of the separate first sheets while transferring each of the separate first sheets in the third direction.